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				<b>Application Number</b>	
				<b>Filing Date</b>	
				<b>First Named Inventor</b>	Kia Silverbrook
				<b>Art Unit</b>	
				<b>Examiner Name</b>	
				<b>Attorney Docket Number</b>	ZE018US
Sheet	1	of	1		

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Examiner Signature		Date Considered	
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